

**AMENDMENTS TO THE SPECIFICATION**

**IN THE ABSTRACT OF THE DISCLOSURE:**

Please replace the Abstract of the Disclosure currently of record with the attached new Abstract of the Disclosure.

IN THE TITLE OF THE INVENTION

Please amend the title of the invention, as it appears on the first page of the specification and in the U.S. Patent and Trademark Office's records, as follows:

--STRUCTURE FOR STACKING CHIP SCALE PACKAGES STACKING APPARATUS FOR INTEGRATED CIRCUIT ASSEMBLY--

IN THE SPECIFICATION:

Please replace the specification with the attached substitute specification. A marked-up version, showing the changes made, is also attached hereto. It is respectfully submitted that no new matter is present in the attached substitute specification.